TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (L^2 - π -MOSV)

2SK2350

Switching Regulator, DC-DC Converter and Motor Drive Applications

• 4-V gate drive

• Low drain-source ON resistance : $RDS(ON) = 0.26 \Omega \text{ (typ.)}$

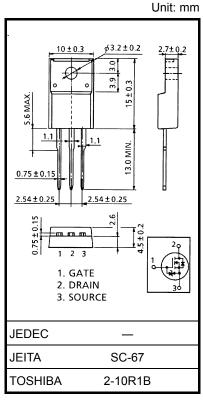
• High forward transfer admittance $|Y_{fs}| = 8 \text{ S (typ.)}$

• Low leakage current : $IDSS = 100 \mu A \text{ (max) (VDS} = 200 \text{ V)}$

• Enhancement mode : $V_{th} = 1.5 \sim 3.5 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteri	stics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	200	V
Drain-gate voltage (R	_{GS} = 20 kΩ)	V_{DGR}	200	V
Gate-source voltage		V _{GSS}	±20	V
Drain current	DC (Note 1)	I _D	8.5	Α
	Pulse (Note 1)	I _{DP}	34	Α
Drain power dissipation	n (Tc = 25°C)	P_{D}	30	W
Single pulse avalanch	e energy (Note 2)	E _{AS}	110	mJ
Avalanche current		I _{AR}	8.5	Α
Repetitive avalanche	energy (Note 3)	E _{AR}	3	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature r	ange	T _{stg}	-55~150	°C



Weight: 1.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	4.16	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 50 V, T_{ch} = 25°C (initial), L = 2.47 mH, R_G = 25 Ω , I_{AR} = 8.5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.



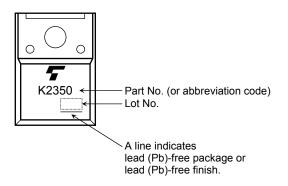
Electrical Characteristics (Ta = 25°C)

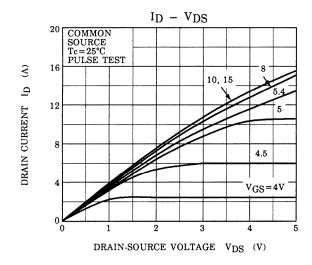
Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μA
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 200 V, V _{GS} = 0 V		_	100	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	200	_	_	V
Gate threshold v	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.5	_	3.5	V
Drain-source O	N resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 5 A		0.26	0.4	Ω
Forward transfer	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 5 A	4	8	_	S
Input capacitano	e	C _{iss}		_	700	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		80	_	pF
Output capacitance		Coss			270	_	
Switching time	Rise time	t _r	$V_{GS} = 10V$ $V_{OUT} = 100V$ $V_{OUT} = 100V$	_	15	_	
	Turn-on time	t _{on}			25	_	ns
	Fall time	t _f		l	15	_	115
	Turn-off time	t _{off}	$V_{DD} = 100V$ Duty $\leq 1\%$, $t_{W} = 10\mu s$		70	_	
Total gate charge (Gate-source plus gate-drain)		Qg		_	17	_	
Gate-source charge		Q _{gs}	$V_{DD} \approx 160 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$		10	_	nC
Gate-drain ("miller") charge		Q_{gd}			7	_	

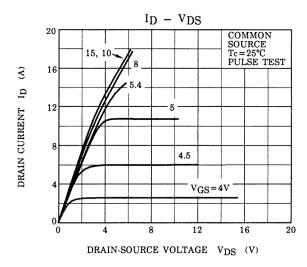
Source-Drain Ratings and Characteristics (Ta = 25°C)

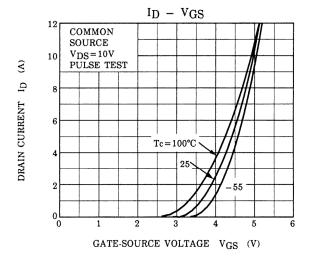
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	8.5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	-	_	34	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 10 A, V _{GS} = 0 V	_	_	-2.0	V
Reverse recovery time	t _{rr}	I _{DR} = 10 A, V _{GS} = 0 V		155		ns
Reverse recovered charge	Q _{rr}	dl _{DR} / dt = 100 A / μs	_	0.8	_	μC

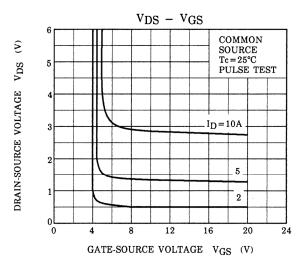
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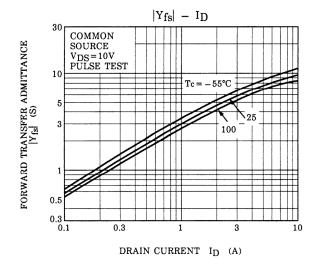


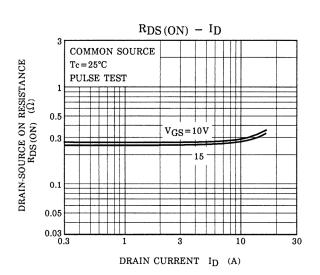


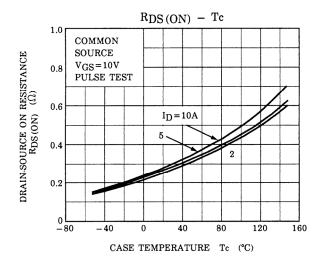


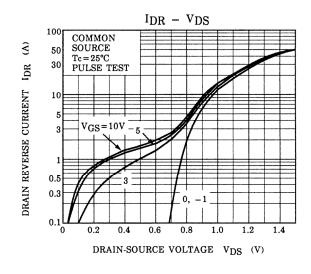


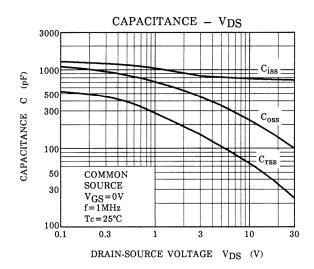


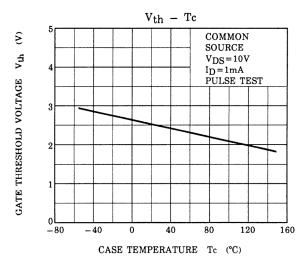


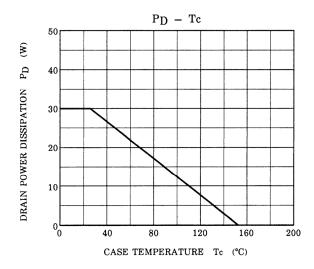


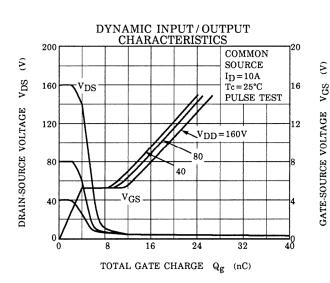


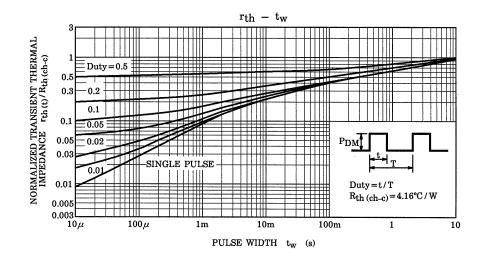


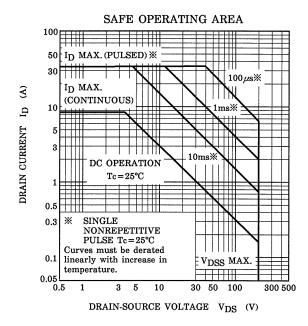


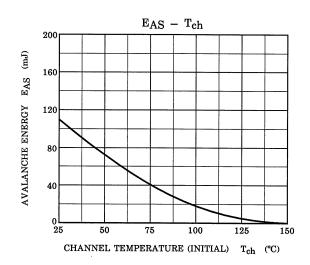


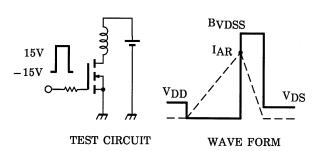












$$R_G = 25 \Omega$$

 $V_{DD} = 50 \text{ V}, L = 2.47 \text{ mH}$ $EAS = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS - VDD}\right)$

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20070701-EN

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